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## Pixus Offers VITA 67 Backplanes for RF over OpenVPX

Waterloo, Ontario — Oct 03, 2018 – Pixus Technologies, a provider of embedded computing and enclosure solutions, has developed a new line of 3U and 6U OpenVPX backplanes with provisions for RF cabling per VITA 67.  The backplanes come in various sizes and slot configuration options.

The VPX307 and VPX607 series for 3U and 6U VITA 67 backplanes respectively, feature various VITA 67.x configuration options.  The backplanes are offered populated with the RF housings/contacts or only with cutouts for later customer installation as needed.   The first in the series is a 3U, 9-slot version per the BKP3-CEN09-15.2.17 profile. Hybrid/development backplanes are also available.

Pixus offers OpenVPX backplanes in sizes up to 16 slots at a 1.0" pitch.  The company also provides high-performance chassis platforms, backplanes, and components in the OpenVPX, VME64x, cPCI Serial, AdvancedTCA, and MicroTCA architectures.

### About Pixus Technologies

Leveraging over 25 years of innovative standard products, the Pixus team is comprised of industry experts in electronics packaging. Founded in 2009 by senior management from Kaparel Corporation, a Rittal company, Pixus Technologies' embedded backplanes and systems are focused primarily on  ATCA, OpenVPX, MicroTCA, and custom designs.   Pixus also has an extensive offering of VME-based and cPCI-based solutions.  In May 2011, Pixus Technologies became the sole authorized North and South American supplier of the electronic packaging products previously offered by Kaparel Corporation and Rittal.